Form PTO-1595 (Rev. 03-11) OMB No. 0651-0027 (exp. 03/31/2016)	U.S. DEPARTMENT OF COMMERCE United States Patent and Trademerk Office
RECORDATION FO	ORM COVER SHEET
PATEN	TS ONLY
To the Director of the U.S. Palent and Trademark Office: Plea	se record the attached documents or the new address(es) below.
Name of conveying party(iee):	2. Name and address of receiving party(les)
Kentaro Fukazawa	Name: Sony Corporation
	Internal Address:
Additional name(s) of conveying party(les) attached?	
3. Nature of conveyance/Execution Date(e):	1-7-1 Konan, Minato-ku
Evacution Data(a): August 1, 2012	Tokyo
Execution Date(s): August 1, 2012  X Assignment Merger Change of Name	108-0075   JAPAN
Security Agreement Joint Research Agreement	City:
Government Interest Assignment	State:
Executive Order 9424, Confirmatory License	Country:Zip;
Other	Additional name(s) & address(es) Yes X No attached?
A. Patent Application No.(s) 13/597,671  Additional numbers attach	B. Patent No.(5)
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Dennis M. Smid, Esq.  LERNER, DAVID, LITTENBERG,  KRUMHOLZ & MENTLIK, LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
Internal Address: Atty. Dkt.: SONYJP 3.0-2886	
Street Address: 600 South Avenue West	Authorized to be charged to deposit account  Enclosed  None required (government interest not affecting title)
City: Westfield	8. Payment Information
State: NJ Zip: 07090	
Phone Number: 908-654-5000	_
Fax Number: 908-654-7866	Deposit Account Number 12-1095
Email Address: ataylor@idlkm.com	Authorized User Name Dennis M. Smid, Esq.
9. Signature:	August 29, 2012
Dennis M. Smid, Esq 34,930	
Name of Person Signing	sheet, attachments, and documents: 2

2875800

PATENT REEL: 028864 FRAME: 0812

RECORDED: 08/29/2012

LDLKM

Attorney Docket No. SONYJP 3.0-2886 SONY Ref. No.: SP320640US00

REEL: 028864 FRAME: 0813

## <u>ASSIGNMENT</u>

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in IMAGE PROCESSING APPARATUS, METHOD AND PROGRAM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

sue markinger mit otilo.		
And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filling date of this application the spaces that follow: Serial Number: 13/597.671 Filing Date: August 29. 2012		
This assignment executed on the dates indicated below.		
KENTARO FUKAZAWA		
Name of first or sole inventor TOKYO, JAPAN	Execution date of U.S. Patent Application	
Residence of First or sole inventor		
Kentago Lupas awa	august 1, 20/2	
Signature of first or sole inventor	Date of this assignment	
Name of second inventor	Execution date of U.S. Patent Application	
Residence of second inventor		
Signature of second inventor	Date of this assignment	
Name of third inventor	Execution date of U.S. Patent Application	
Residence of third inventor		
Signature of third inventor	Date of this assignment PATENT	